

/ Descriptions

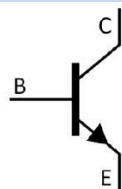
TO-92 NPN

/ Features

h_{FE} , , KTA1266

/ Applications

/ Equivalent Circuit



/ Pinning



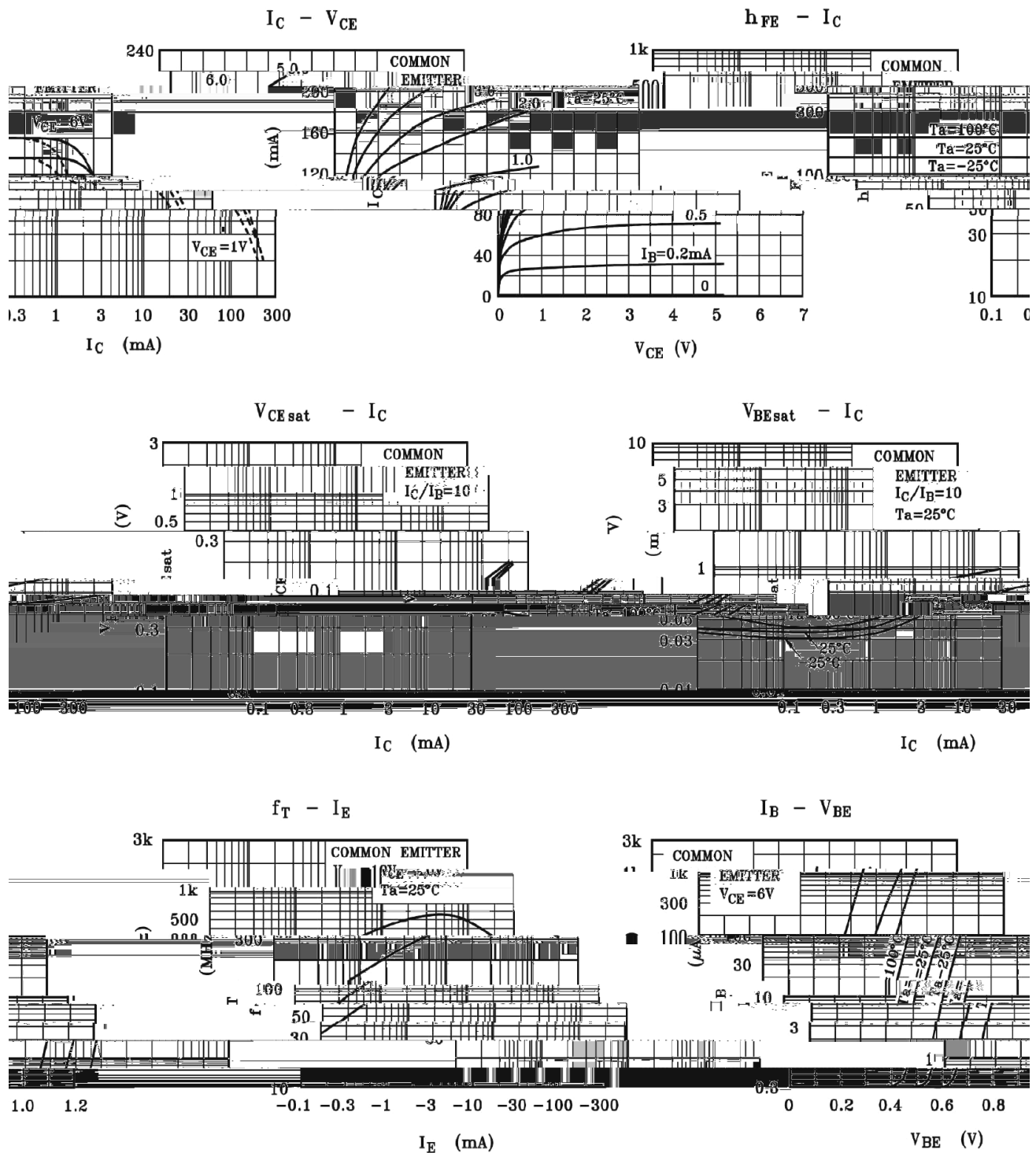
/ h_{FE} Classifications & Marking

		~	

						μ
						μ

Ω

/ Electrical Characteristic Curve

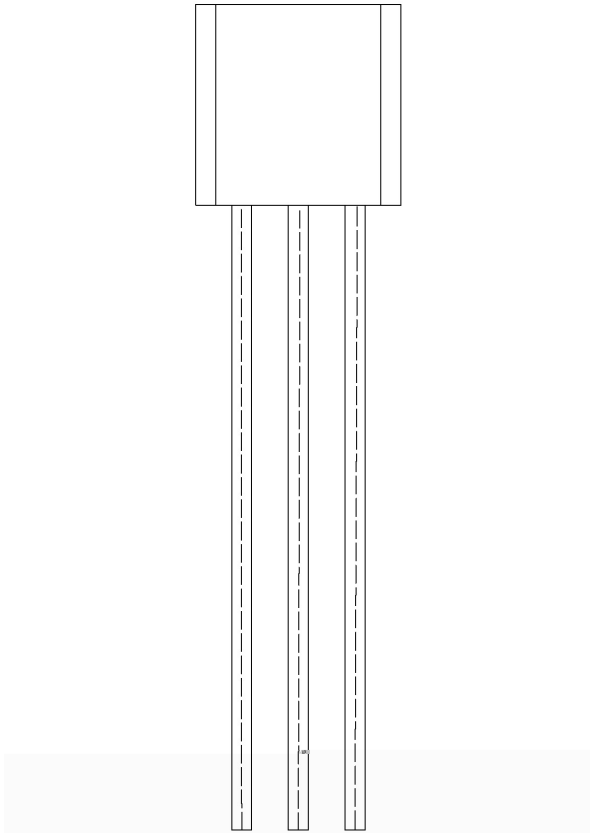


T0-92

Unit: mm

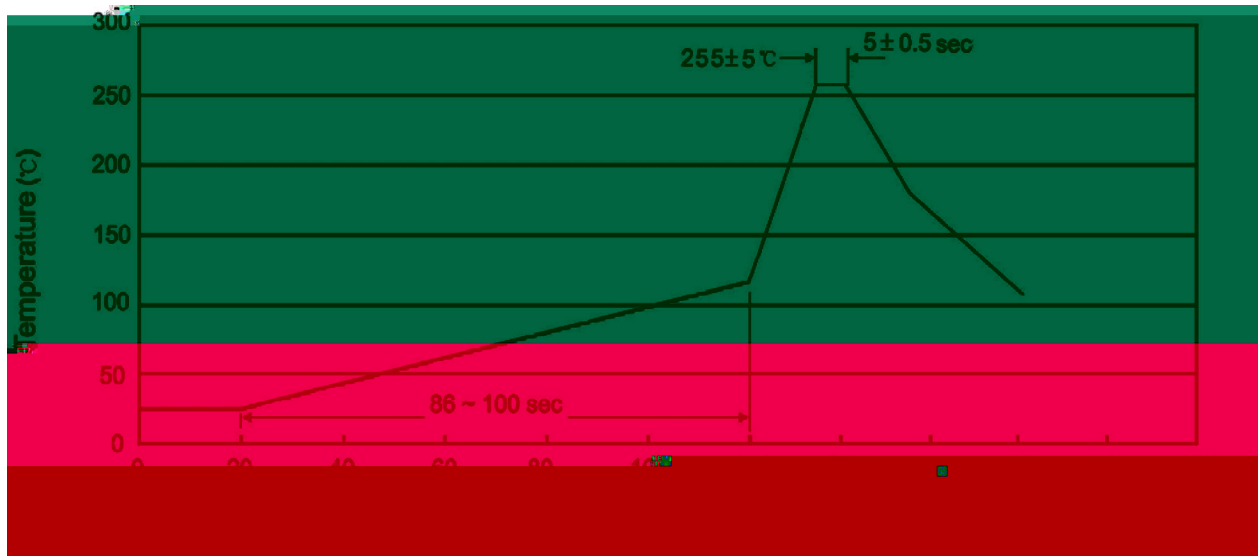


/ Marking Instructions



BR:
C3198
GR: h_{FE}

() / Temperature Profile for Dip Soldering(Pb-Free)

 $\pm$ $\pm$ $\pm$ $\pm$

/ Resistance to Soldering Heat Test Conditions

 $\pm$ $\pm$

/ Packaging SPEC.

封装形式	包装数量					包装尺寸		
	只 袋	袋 盒	只 盒	盒 箱	只 箱	袋	盒	箱

封装形式	包装数量					包装尺寸	
	只 纸带	纸带 盒	纸带层 盒	盒 箱	只 箱	盒	箱
							小箱 大箱

/ Notices